## Silicon P-Channel MOS FET

# **HITACHI**

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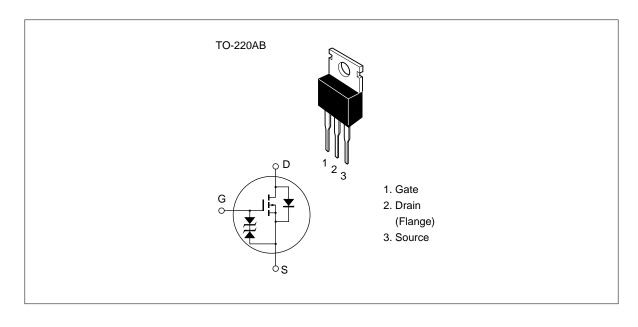
## **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
  - Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

#### **Outline**



## **Absolute Maximum Ratings** $(Ta = 25^{\circ}C)$

| Item                                      | Symbol                       | Ratings     | Unit |
|---|------------------------------|-------------|------|
| Drain to source voltage                   | $V_{\scriptscriptstyle DSS}$ | -60         | V    |
| Gate to source voltage                    | $V_{GSS}$                    | ±20         | V    |
| Drain current                             | I <sub>D</sub>               | -20         | A    |
| Drain peak current                        | I <sub>D(pulse)</sub> *1     | -80         | A    |
| Body to drain diode reverse drain current | I <sub>DR</sub>              | -20         | А    |
| Channel dissipation                       | Pch*2                        | 75          | W    |
| Channel temperature                       | Tch                          | 150         | °C   |
| Storage temperature                       | Tstg                         | -55 to +150 | °C   |

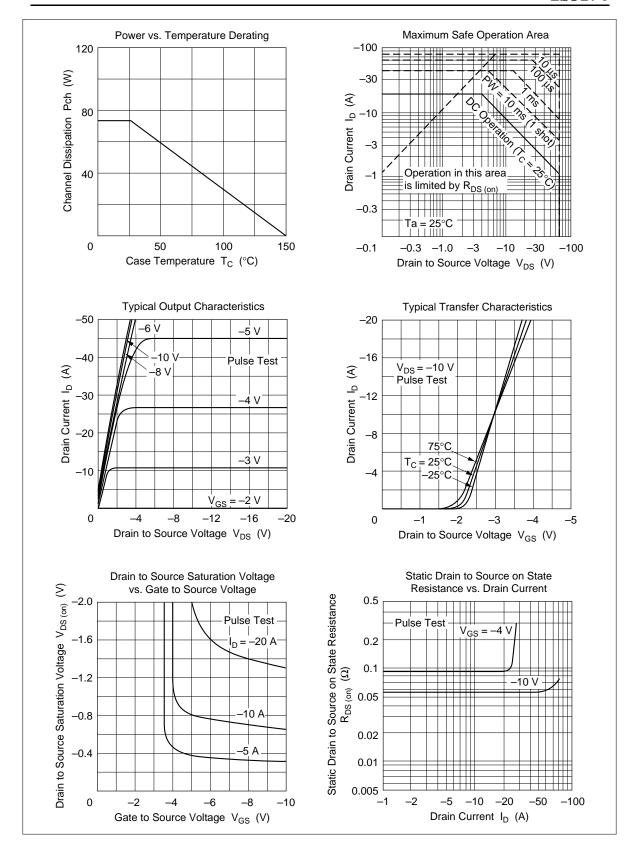
Notes 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

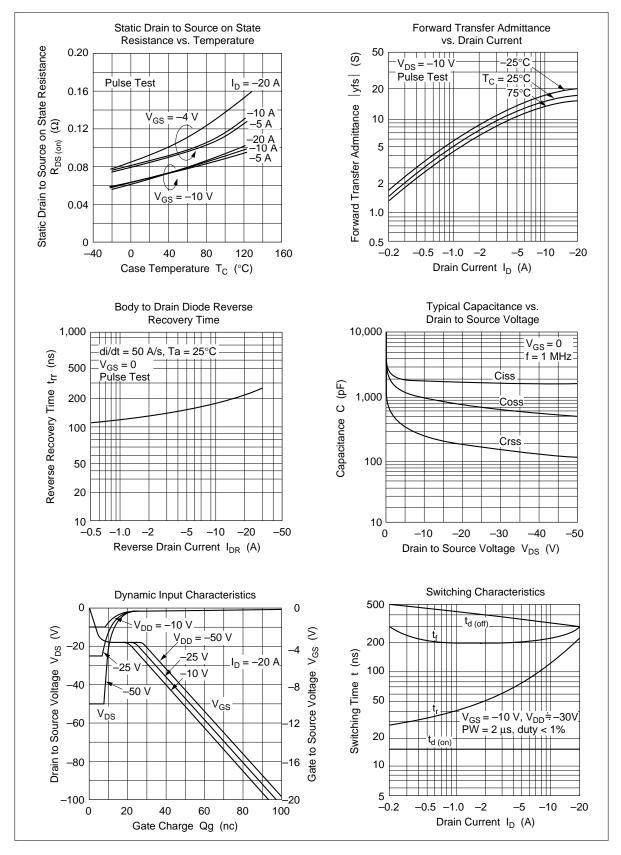
2. Value at  $T_c = 25^{\circ}C$ 

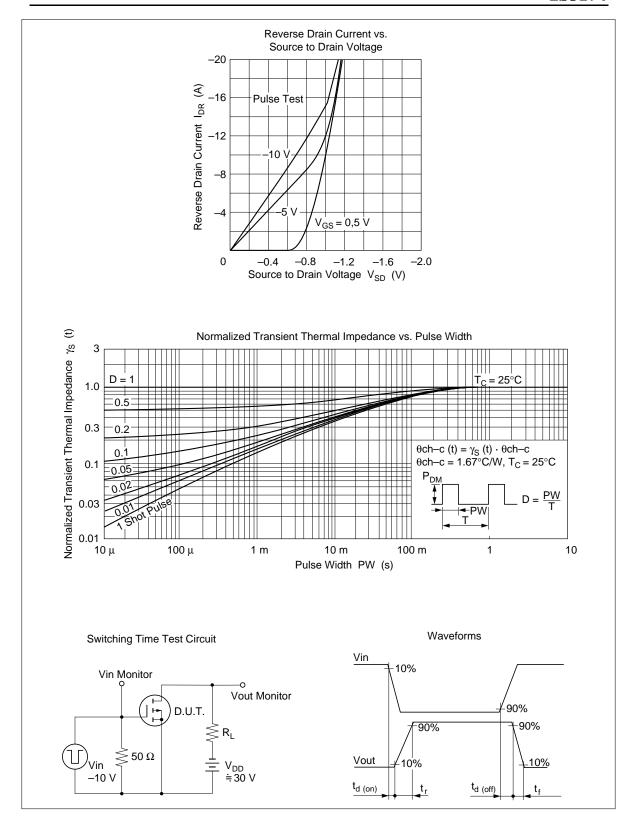
## **Electrical Characteristics** (Ta = 25°C)

| Item                                      | Symbol              | Min  | Тур   | Max   | Unit | Test conditions  |
|---|---------------------|------|-------|-------|------|--|
| Drain to source breakdown voltage         | $V_{(BR)DSS}$       | -60  | _     | _     | V    | $I_{D} = -10 \text{ mA}, V_{GS} = 0$                                       |
| Gate to source breakdown voltage          | $V_{(BR)GSS}$       | ±20  | _     | _     | V    | $I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$                                    |
| Gate to source leak current               | I <sub>GSS</sub>    | _    | _     | ±10   | μΑ   | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$                                    |
| Zero gate voltage drain current           | I <sub>DSS</sub>    | _    | _     | -250  | μΑ   | $V_{DS} = -50 \text{ V}, V_{GS} = 0$                                       |
| Gate to source cutoff voltage             | $V_{GS(off)}$       | -1.0 | _     | -2.0  | V    | $I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$                              |
| Static drain to source on state           | R <sub>DS(on)</sub> | _    | 0.065 | 0.085 | Ω    | $I_D = -10 \text{ A}, V_{GS} = -10 \text{ V}^{*1}$                         |
| resistance                                |                     | _    | 0.09  | 0.13  | _    | $I_D = -10 \text{ A}, V_{GS} = -4 \text{ V}^{*1}$                          |
| Forward transfer admittance               | y <sub>fs</sub>     | 8    | 13    |       | S    | $I_D = -10 \text{ A}, V_{DS} = -10 \text{ V}^{*1}$                         |
| Input capacitance                         | Ciss                | _    | 1850  |       | pF   | $V_{DS} = -10 \text{ V}, V_{GS} = 0,$                                      |
| Output capacitance                        | Coss                | _    | 990   | _     | pF   | f = 1 MHz  |
| Reverse transfer capacitance              | Crss                | _    | 265   |       | pF   | _  |
| Turn-on delay time                        | t <sub>d(on)</sub>  | _    | 15    |       | ns   | $I_D = -10 \text{ A}, V_{GS} = -10 \text{ V},$                             |
| Rise time                                 | t <sub>r</sub>      | _    | 125   | _     | ns   | $R_L = 3 \Omega$   |
| Turn-off delay time                       | t <sub>d(off)</sub> | _    | 345   |       | ns   | _  |
| Fall time                                 | t <sub>f</sub>      | _    | 235   | _     | ns   | _  |
| Body to drain diode forward voltage       | $V_{DF}$            | _    | -1.2  | _     | V    | $I_F = -20 \text{ A}, V_{GS} = 0$  |
| Body to drain diode reverse recovery time | t <sub>rr</sub>     | _    | 230   | _     | ns   | $I_F = -20 \text{ A}, V_{GS} = 0,$<br>$di_F/dt = 50 \text{ A}/\mu\text{s}$ |

Note 1. Pulse test







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